

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE15H11T uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in Automotive applications and a wide variety of other applications.

General Features

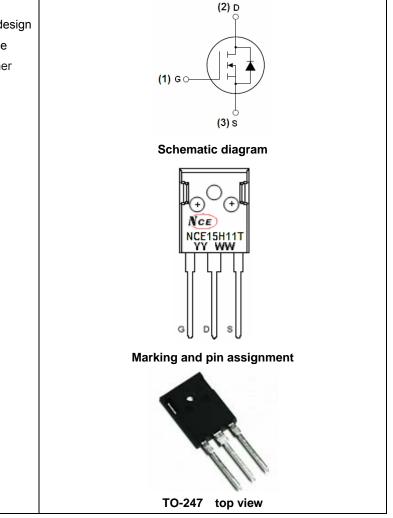
- $V_{DSS} = 150V, I_D = 110A$ $R_{DS(ON)} < 13m\Omega @ V_{GS} = 10V$ (Typ: 10 m Ω)
- Good stability and uniformity with high E_{AS}
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Application

- Automotive applications
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE15H11T	NCE15H11T	TO-247	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vdss	150	V	
Gate-Source Voltage	V _{GS}	±20	V	
Drain Current-Continuous	I _D	110	А	
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	80	Α	
Pulsed Drain Current	I _{DM}	390	А	
Maximum Power Dissipation	PD	385	W	
Derating factor		2.57	W/℃	
Single pulse avalanche energy (Note 3)	E _{AS}	1800	mJ	
Peak Diode Recovery dv/dt (Note 4)	dv/dt	3	V/ns	





NCE15H11T

Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 1)	R _{θJC}	0.39	°C/W

Electrical Characteristics (T_c=25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V_{GS} =0V I _D =250µA	150	160	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =150V, V_{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±200	nA
On Characteristics	·		•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A	-	10	13	mΩ
Forward Transconductance	g fs	V _{DS} =50V,I _D =40A	50	-	-	S
Dynamic Characteristics	·		•			
Input Capacitance	C _{lss}		-	16500	-	PF
Output Capacitance	C _{oss}	V _{DS} =25V,V _{GS} =0V, F=1.0MHz	-	1344	-	PF
Reverse Transfer Capacitance	C _{rss}		-	1025	-	PF
Switching Characteristics			-			
Turn-on Delay Time	t _{d(on)}		-	20	-	nS
Turn-on Rise Time	tr	V_{DD} =30V,I _D =2A,R _L =15 Ω	-	130	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =2.5 $\Omega^{(Note2)}$	-	50	-	nS
Turn-Off Fall Time	t _f		-	60	-	nS
Total Gate Charge	Qg	<u>)/ -20)/ -20</u> /	-	377	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =30V,I _D =30A, V _{GS} =10V ^(Note2)	-	79	-	nC
Gate-Drain Charge	Q _{gd}	VGS-10V	-	118	-	nC
Drain-Source Diode Characteristics			-			
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =40A	-	-	1.2	V
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 40A	-	60	_	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note2)	-	90	_	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

1. Surface Mounted on FR4 Board, t \leq 10 sec.

2. Pulse Test: Pulse Width \leq 400µs, Duty Cycle \leq 2%.

3. EAS condition: Tj=25 $^\circ\!\!\mathrm{C}$,V_{DD}=75V,V_G=10V,L=2mH,Rg=25\Omega



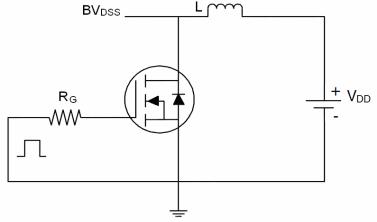
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Pb Free Product

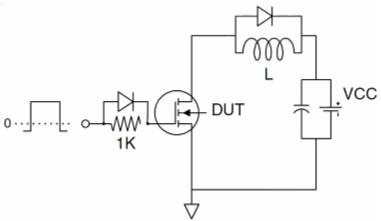


Test circuit

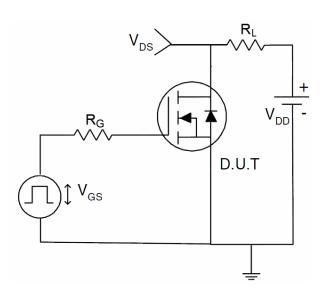
1) E_{AS} test Circuits



2) Gate charge test Circuit:



3) Switch Time Test Circuit:







10

∕GS

400

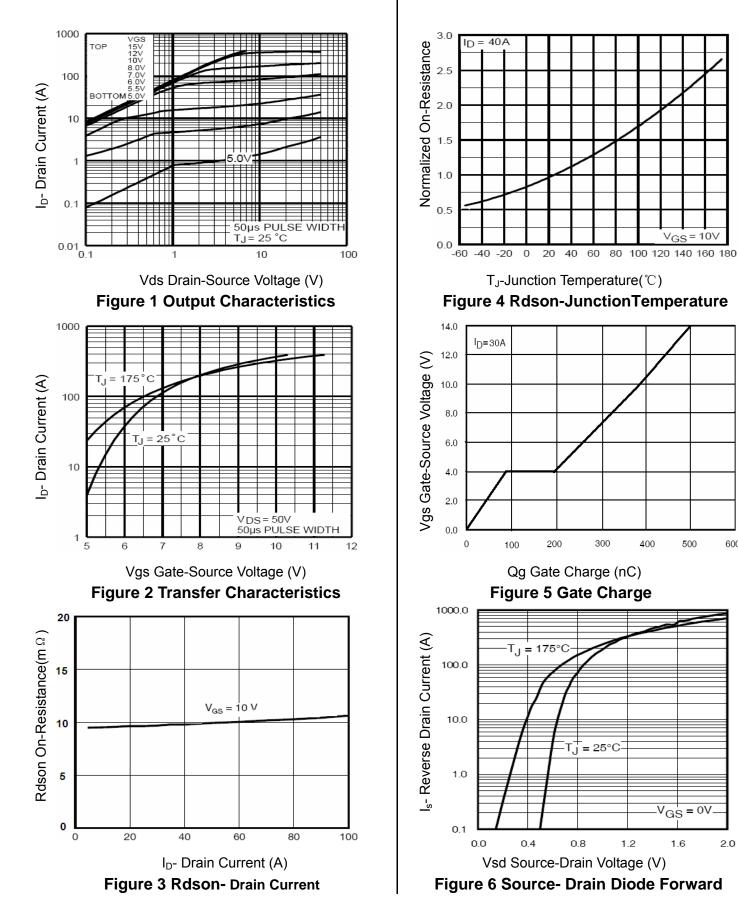
500

 $V_{GS} = 0V$

1.6

600

Typical Electrical and Thermal Characteristics



2.0





NCE15H11T

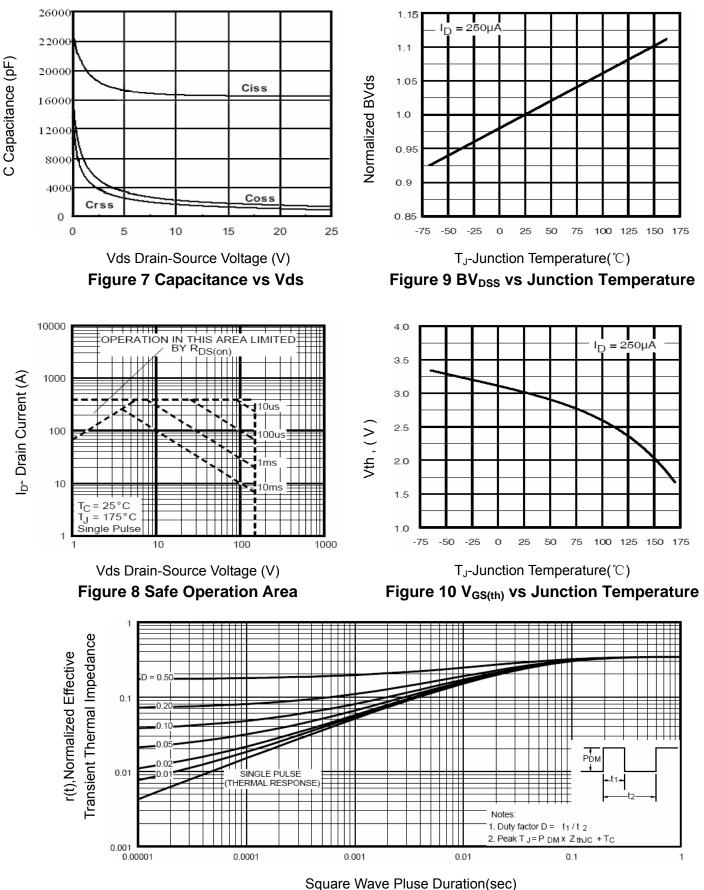


Figure 11 Normalized Maximum Transient Thermal Impedance

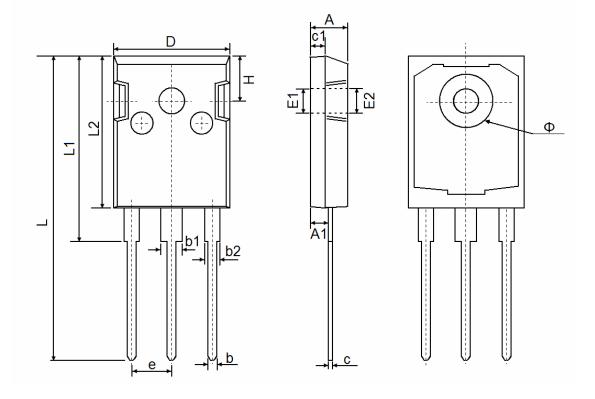
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TO-247 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches			
	Min.	Max.	Min.	Max.		
A	4.850	5.150	0.191	0.200		
A1	2.200	2.600	0.087	0.102		
b	1.000	1.400	0.039	0.055		
b1	2.800	3.200	0.110	0.126		
b2	1.800	2.200	0.071	0.087		
С	0.500	0.700	0.020	0.028		
c1	1.900	2.100	0.075	0.083		
D	15.450	15.750	0.608	0.620		
E1	3.50	0 REF	0.138 REF			
E2	3.600 REF		0.142 REF			
L	40.900	41.300	1.610	1.626		
L1	24.800	25.100	0.976	0.988		
L2	20.300	20.600	0.799	0.811		
Ф	7.100	7.300	0.280	0.287		
е	5.450 TYP		0.215 TYP			
Н	5.980) REF	0.235	0.235 REF		







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